



SSC65TR20GT6

Trench FSII Fast IGBT

➤ Features

V_{CES}	V_{GES}	I_C
650V	$\pm 20V$	125A@25°C
		75A@100°C

➤ Description

Using trench design and advanced FS (Field Stop) second generation technology, the 650V Trench FSII IGBT offers superior conduction and switching performances, and easy parallel operation.

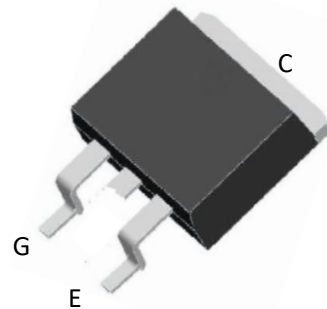
➤ Applications

- Hair removal device
- Flash light

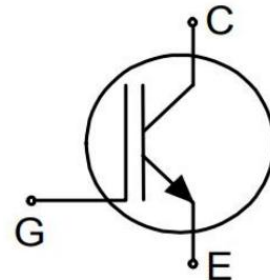
➤ Ordering Information

Device	Package	Shipping
SSCG75N65GT6	TO263-3L	800/Reel

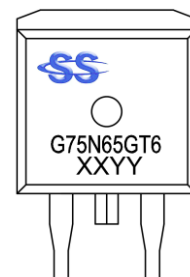
➤ Pin Configuration



TO263-3L (Top View)



Pin Configuration



Marking

(XXYY: Internal Traceability Code)



➤ **Absolute Maximum Ratings ($T_{vj}=25^{\circ}\text{C}$ unless otherwise noted)**

Symbol	Parameter		Ratings	Unit
V_{CES}	Collector-Emitter Voltage		650	V
V_{GES}	Gate-Emitter Voltage		± 20	V
I_C	Collector Current	$T_C=25^{\circ}\text{C}$	125	A
		$T_C=100^{\circ}\text{C}$	75	
I_{Cpuls}	Pulsed Collector Current, t_p limited by T_{vjmax}		300	A
P_D	Power Dissipation ^a	$T_C=25^{\circ}\text{C}$	535	W
		$T_C=100^{\circ}\text{C}$	267	
T_J	Operating Junction and Storage Temperature Range		-40~175	$^{\circ}\text{C}$
T_{STG}	Operating Junction and Storage Temperature Range		-55~150	$^{\circ}\text{C}$

➤ **Thermal Resistance Ratings**

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance		40	$^{\circ}\text{C/W}$
$R_{\theta JC}$	Thermal Resistance, Junction to Case for IGBT		0.28	



➤ **Electrical Characteristics of IGBT (T_{vj}=25°C unless otherwise noted)**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V _{(BR)CES}	Collector-Emitter Breakdown Voltage	V _{GE} = 0V, I _C = 0.25mA	650			V
I _{CES}	Collector-Emitter Leakage Current	V _{GE} =0V, V _{CE} =650V, T _{vj} =25°C			50	uA
I _{GES(F)}	Gate to Emitter Forward Leakage	V _{GE} = +20V, V _{CE} = 0V			100	nA
I _{GES(R)}	Gate to Emitter Reverse Leakage	V _{GE} = -20V, V _{CE} = 0V			-100	nA
V _{CE(sat)}	Collector-Emitter Saturation Voltage	I _C =75A, V _{GE} =15V, T _{vj} =25°C		1.7		V
		I _C =75A, V _{GE} =15V, T _{vj} =175°C		2.2		V
V _{GE(th)}	Gate Threshold Voltage	I _C = 1mA, V _{CE} = V _{GE}	5.0	5.3	5.7	V
C _{ies}	Input Capacitance	V _{CE} = 30V, V _{GE} = 0V, f = 1MHz		4250		pF
C _{oes}	Output Capacitance			200		
C _{res}	Reverse Transfer Capacitance			30		
T _{D(ON)}	Turn-on delay time	T _{vj} =25°C, V _{CC} =400V, I _C =75A, V _{GE} =0/15V, R _g =10Ω, Inductive Load		54		ns
T _r	Rise time			130		
T _{D(OFF)}	Turn-off delay time			163		
T _f	Fall time			94		
E _{on}	Turn-On Switching Loss			3.2		mJ
E _{off}	Turn-Off Switching Loss			2.1		
E _{ts}	Total Switching Loss			5.3		
T _{D(ON)}	Turn-on delay time	T _{vj} =175°C, V _{CC} =400V, I _C =75A, V _{GE} =0/15V, R _g =10Ω, Inductive Load		52		ns
T _r	Rise time			126		
T _{D(OFF)}	Turn-off delay time			183		
T _f	Fall time			106		
E _{on}	Turn-On Switching Loss			4.7		mJ
E _{off}	Turn-Off Switching Loss			2.7		
E _{ts}	Total Switching Loss			7.4		
Q _G	Total Gate Charge	V _{CC} = 520V, I _C = 75A, V _{GE} = 0/15V		130		nC

➤ **Typical Performance Characteristics ($T_{vj}=25^{\circ}\text{C}$ unless otherwise noted)**

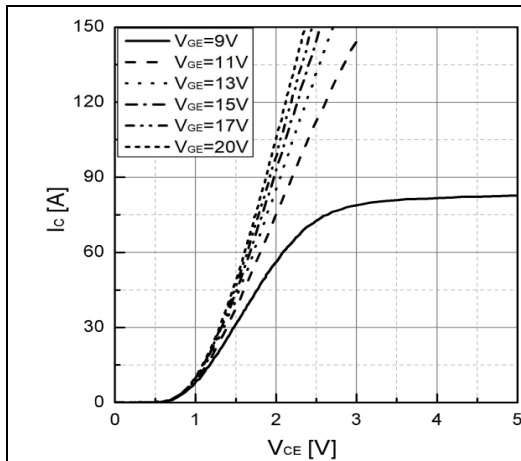


Fig 1. Typical output characteristic ($T_{vj}=25^{\circ}\text{C}$)

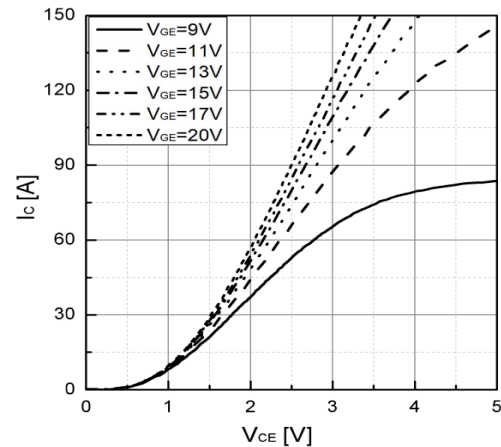


Fig 2. Typical output characteristic ($T_{vj}=175^{\circ}\text{C}$)

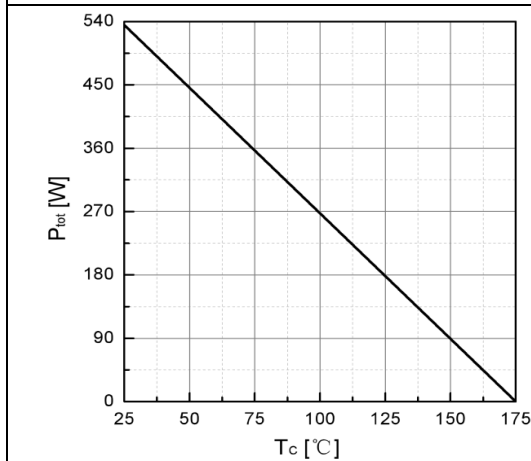


Fig 3. Power dissipation as a function of TC

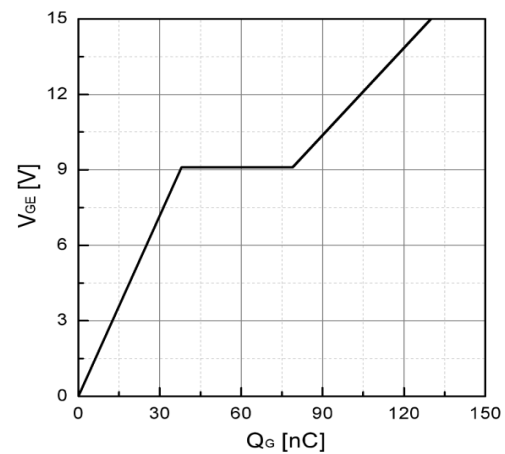
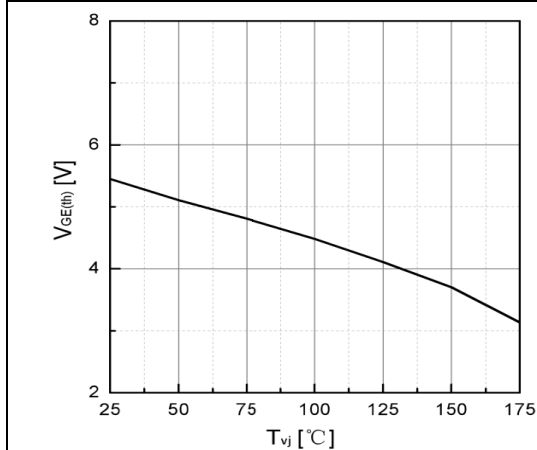


Fig 4. Typical Gate charge



**Fig 5. Typical $V_{GE(th)}$ as a function of T_{vj}
($I_c=1\text{mA}$)**

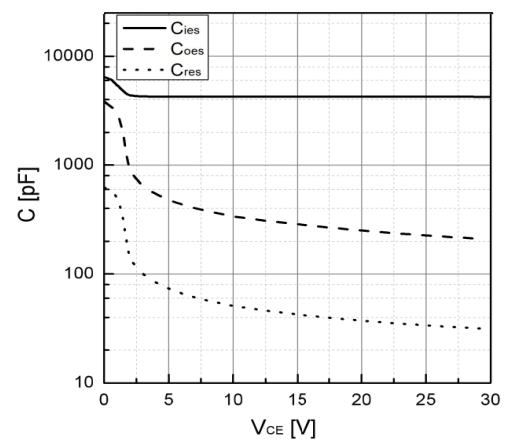


Fig 6. Typical VF as a function of T_{vj}

➤ Typical Performance Characteristics ($T_{vj}=25^{\circ}\text{C}$ unless otherwise noted)

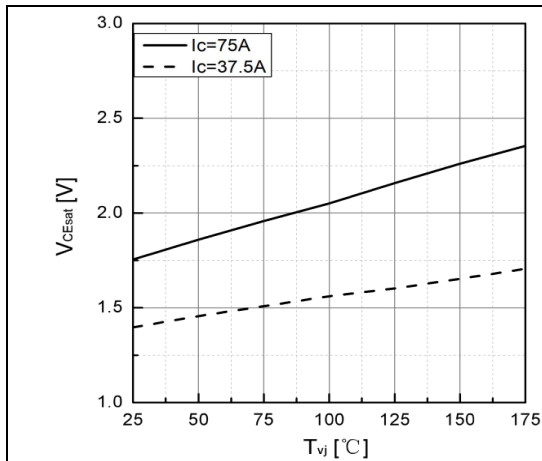


Fig 7. Typical VCEsat as a function of T_{vj}

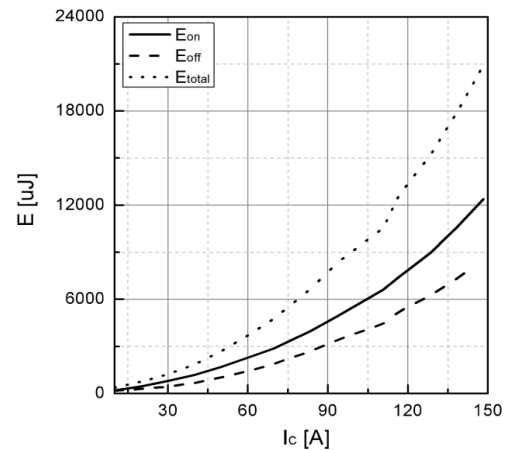


Fig 8. Typical switching energy losses as a function of I_c

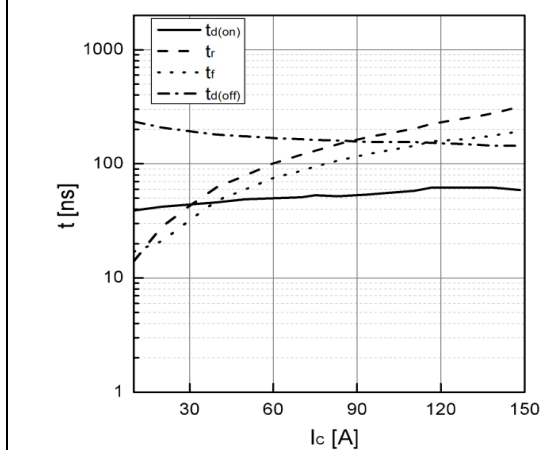


Fig 9. Typical switching time as a function of I_c

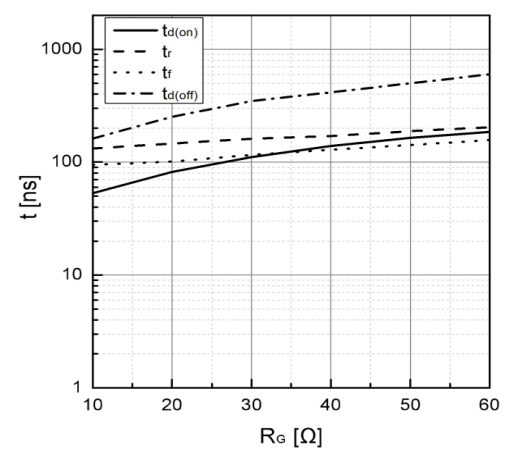


Fig 10. Typical switching times as a function of R_G

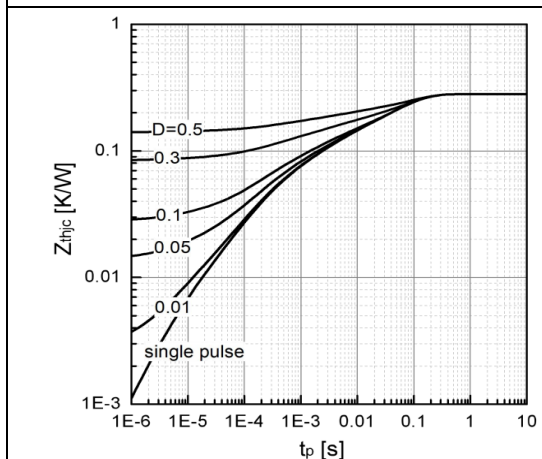


Fig 11. Transient thermal impedance of IGBT

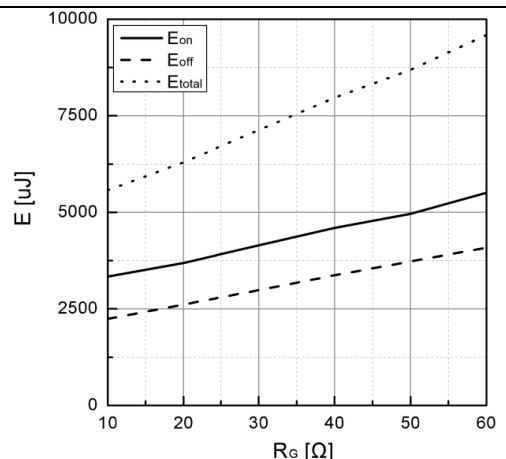
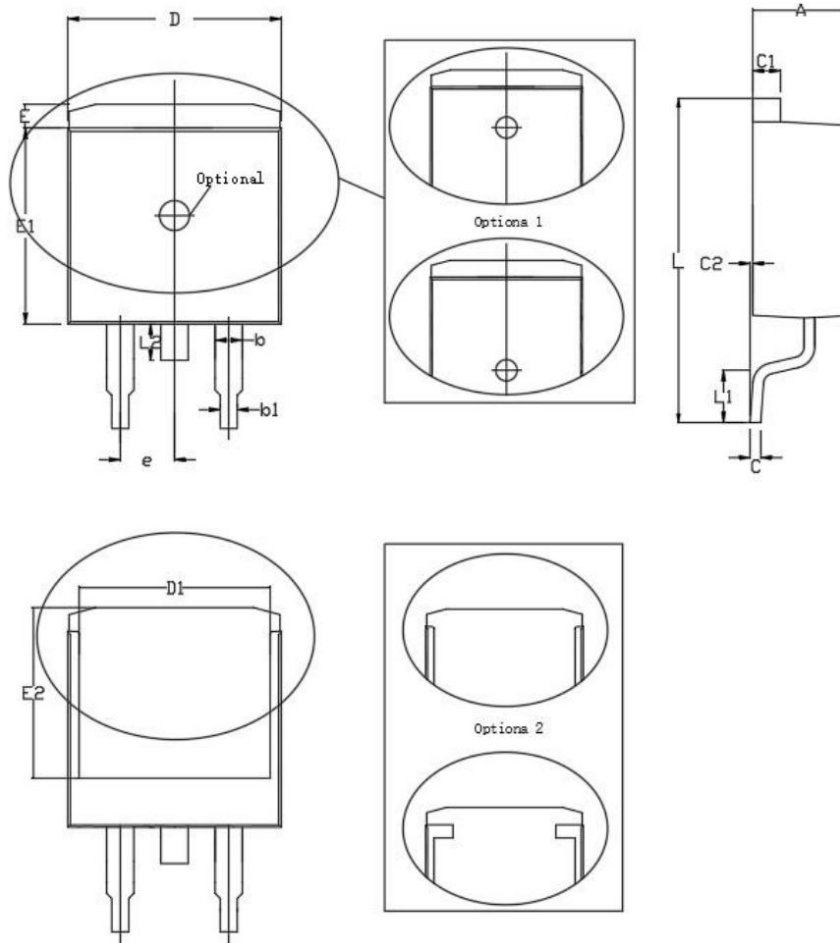


Fig 12. Typical switching energy losses as a function of R_G

➤ Package Information

TO263-3L



Symbol	MILL IMETER			Symbol	MILL IMETER		
	Min	Nom	Max		Min	Nom	Max
A	4.40	4.55	4.70	E	1.02	1.27	1.67
b	1.17	1.28	1.37	E1	8.38	9.15	9.65
b1	0.51	0.80	0.91	E2	6.85	8.00	8.40
C	0.38	0.47	0.74	e	2.54BSC		
C1	1.14	1.30	1.65	L	14.61	15.24	15.88
C2	0.02	0.10	0.20	L1	1.50	/	2.60
D	9.65	10.00	10.70	L2	1.30	1.50	1.75
D1	6.25	7.40	8.37				



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